

Customer No.: 31561  
Application No.: 10/604,650  
Docket No.: 9246-US-PA

AMENDMENT

**Please amend the application as indicated hereafter.**

In the Claims :

**1. (original) A substrate, comprising:**

**a dielectric structure;**

**an interconnection structure interlacing inside the dielectric structure;**

**and**

**a solder mask covering the dielectric structure, wherein the solder mask has a coefficient of thermal expansion substantially equal to the dielectric structure contacting the solder mask.**

**2. (original) The substrate according to claim 1, wherein the material of the solder mask is epoxy resin.**

**3. (original) The substrate according to claim 1, wherein the material of the solder mask is bismaleimide-triazine.**

**4. (original) The substrate according to claim 1, wherein the solder mask further covers the interconnection structure, the solder mask having at least one opening to expose the interconnection structure.**

**5. (original) The substrate according to claim 1, wherein the solder mask has the same material as the dielectric structure contacting the solder mask.**

**6. (original) A substrate, comprising:**

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**6. (original) A substrate, comprising:**

**a dielectric structure;**

**an interconnection structure interlacing inside the dielectric structure;**

**and**

**a solder mask covering the dielectric structure, wherein the glass transition temperature of the material used for manufacturing the solder mask is over 200 degree C.**

**7. (original) The substrate according to claim 6, wherein the solder mask further covers the interconnection structure, the solder mask having at least one opening to expose the interconnection structure.**

**8. (original) The substrate according to claim 6, wherein the material of the solder mask is epoxy resin.**

**9. (original) The substrate according to claim 6, wherein the material of the solder mask is bismaleimide-triazine.**

**10.-25. (cancelled)**